

Innovations in Supercritical Fluid Technology

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Gleason



**Raupp, Alford,
Beaudoin**



Rothschild



NSF/SRC ERC for Environmentally Benign Semiconductor Manufacturing



Innovations in Supercritical Fluid Technology

Supercritical Fluid

Applications:

- Solvent replacement
 - Extractions
 - Drying processes
 - Polymerizations
 - Environmental applications
 - Supercritical water oxidation
 - Rapid expansion powder formation
- Pharmaceuticals and food processing

Influence on Thrust D-

Lithography:

- Similar challenges & limitations
 - up of processing

Supercritical Fluid: Environmental Compatibility



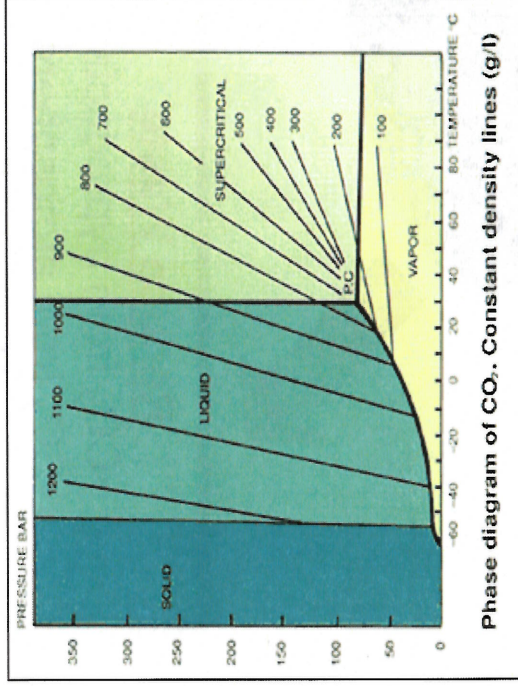
Reduce Waste

- CO₂ from byproducts
- CO₂ from atmosphere
 - Recyclable
- No aqueous waste produced
- Water replaces organic solvents

Reduce Biohazards

- No solvent exposure hazard
- Non-flammable
 - Non-toxic
- Water and CO₂

Supercritical Carbon Dioxide



	GAS	Supercritical Fluid		Liquid
	P=0.1 MPa T= 15 °C	T _c , P _c	T _c , 4P _c	P=0.1 MPa T= 15°C
Density ρ (g/cm ³)	0.0006 – 0.002	0.2- 0.5	0.4- 0.9	0.6- 1.6
Viscosity μ Pa•s	10-30	10-30	30-90	200-3000
Diffusion cm ² /s	0.1- 0.4	0.7x10 ⁻³	0.2x10 ⁻³	0.2x10 ⁻⁵ 2.0x10 ⁻⁵

- High & variable density
- Higher diffusion than liquid
- Viscosity comparable to gas
- Tunable solvating power

Supercritical Fluids

Critical Point: T_c P_c

CO ₂	31 °C	73.8 atm
Ethanol	240.9 °C	64.1 atm
CO ₂ + 7 mol% Et:	52 °C	97 atm
Water	374 °C	220 atm

Disadvantages:

- Elevated pressures required
- Compression costs
- High capital equipment investment

Advantages:

- Controllable dissolving power
- SCF easily recoverable from extract
- Non-toxic solvents, no residues
- Separations not possible by traditional methods can be effected
- Thermally labile compounds can be extracted, low temperature use
- Relatively inexpensive solvents, continuously recycled.

Supercritical Water

Water: Reaction Solvent Affect

ϵ_{H_2O} : 78 at STP

ϵ_{H_2O} : 2-30 within SCF region (6 at Tc, Pc)

$\epsilon_{Propane}$: 1.6

$\epsilon_{Acetone}$: 20.7

$\epsilon_{Carbon\ Tetrachloride}$: 2.2

$\epsilon_{Methanol}$: 32.6

- Organic substances become soluble
- Tunable separations/ chromatography

Water: Ion Product Affect

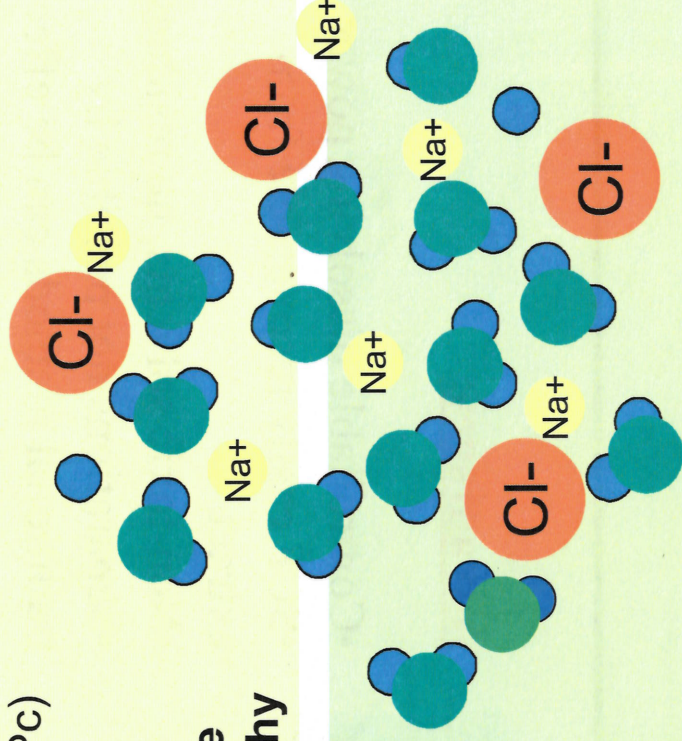
$$K_w = [H^+][OH^-]$$

$[H^+] = 1 \times 10^{-7}$ at STP

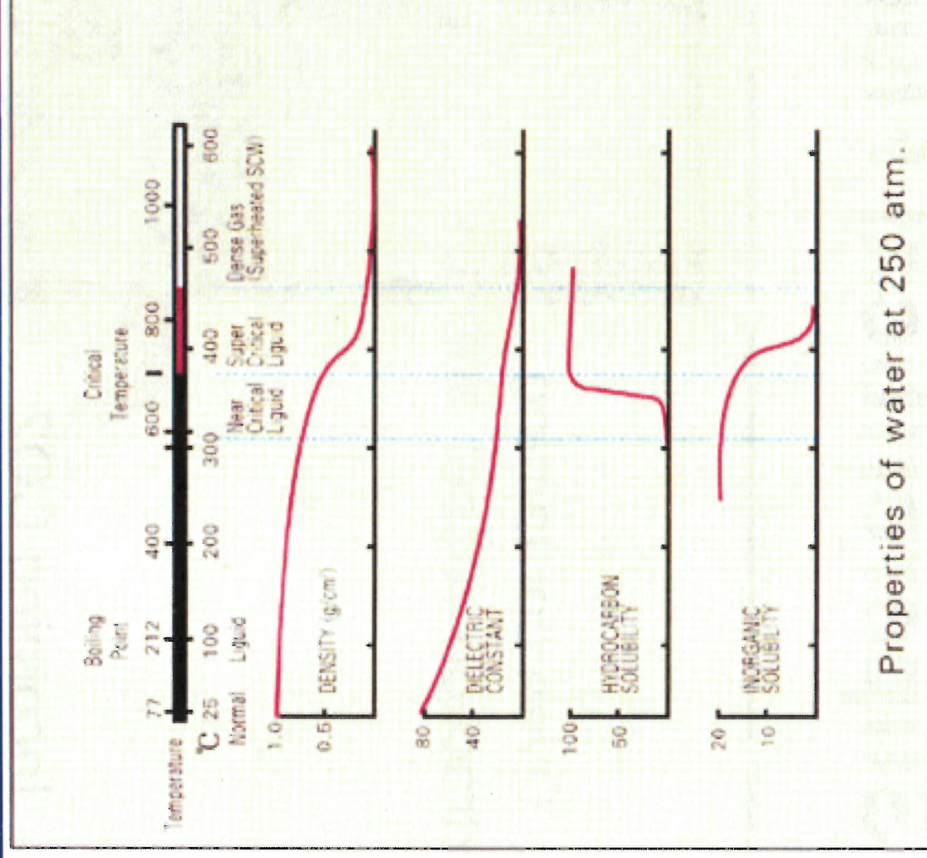
$[H^+] = 3 \times 10^{-6}$ at 300 °C

- Acid or base catalyst
- Electrolyte solvent
- Effective Hydrolysis

SCW: 77% contact ion pairs
H2O: 2.6% CIP; 2-6 x more H-bonds
Chialvo: molecular simulations



Supercritical Water



Changes occur at SCF transition:

Decrease in Density

Decrease in Dielectric Constant

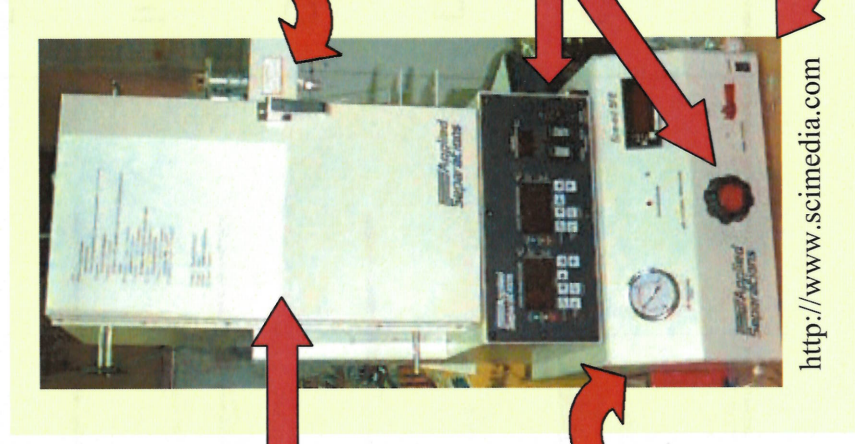
Increase in Hydrocarbon Solubility

Decrease in Inorganic Solubility

<http://www.labkorea.com/products/reactor/>

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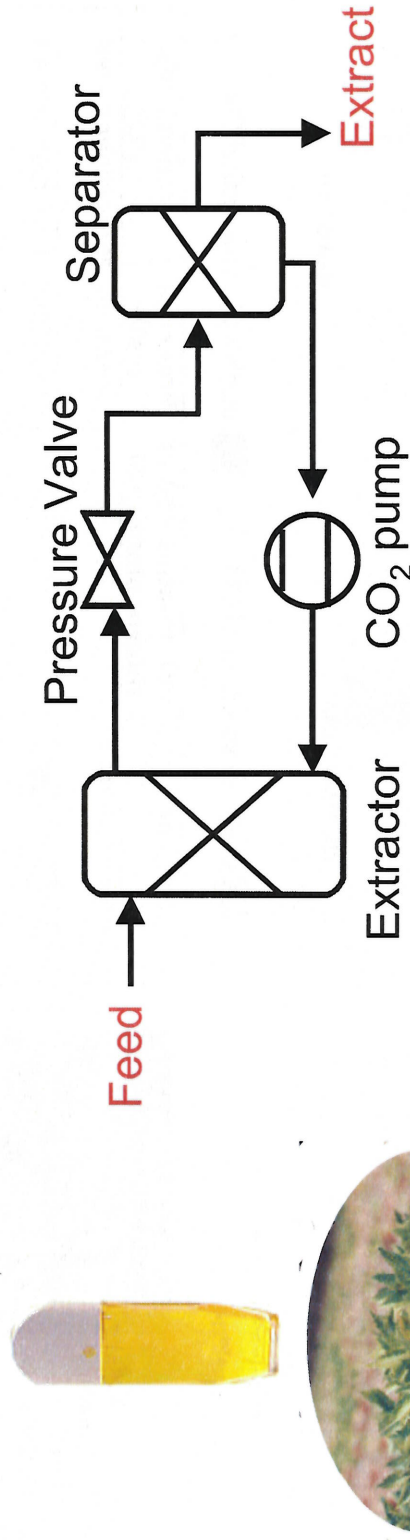
Supercritical Fluid Extraction



1. Incoming CO₂ mobile phase
2. Pressurizing pump
3. Digital Temperature and Pressure control
4. Oven containing extraction vessel
5. Trapping vessel

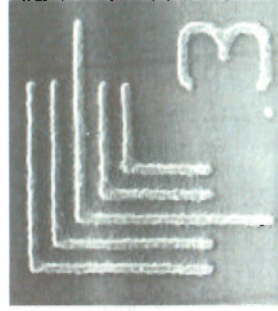
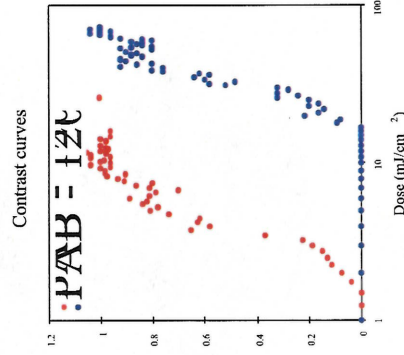
Supercritical Fluid Extraction

Inexpensive, no solvent residue, non-organic, easy processing control.



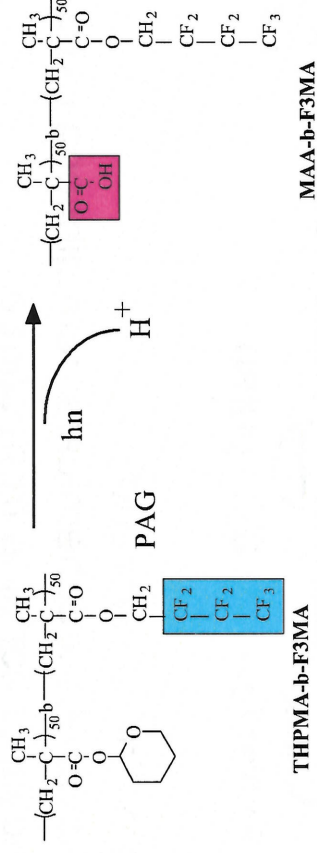
- Purification of odorants
- Removal of agrochemicals from ginseng extract.
- Removal of caffeine from coffee
- Removal of water from ethanol.
- Fractionation; removal of monomer from polymer
- CO₂ Dry cleaning to replace carcinogenic PERC

Solvent Replacement: Lithography



Thickness ~ 2700 Å
Halo alkyl Iodonium
PAG ~ 1 wt %
PAB - 120C/60s
PEB - 120C/60s
SCF CO₂ at 45C,
4500 psi

Narayanan Sundararajan
Cornell University

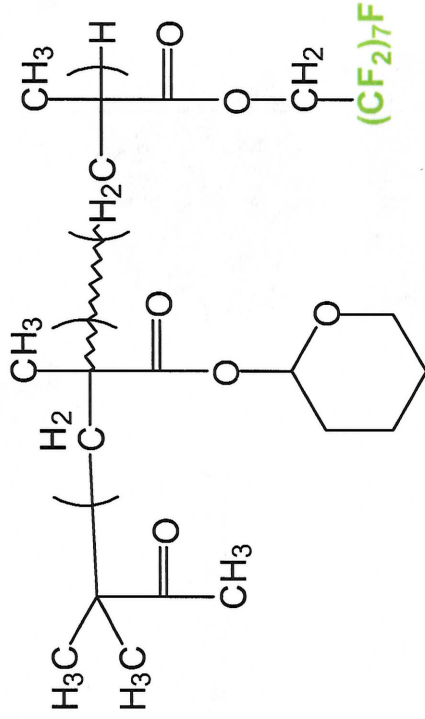


■ soluble in supercritical CO₂ ■ insoluble in supercritical CO₂

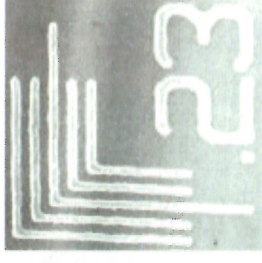
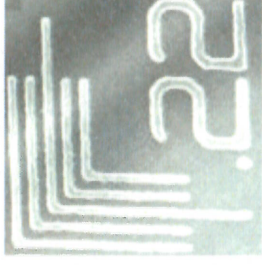
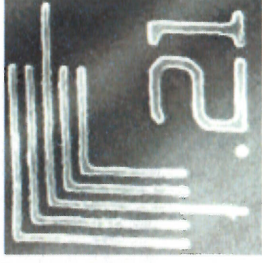
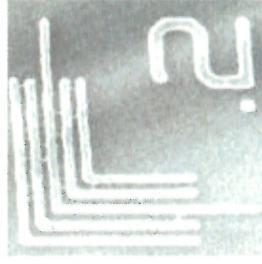
Polymer	Vol. fraction (%) of fluorocomponent	Pressure (psi)	Temperature (°C)
THPMA-b-F3MA	22	Insoluble at conditions tried	
THPMA-b-F3MA	32	Insoluble at conditions tried	
THPMA-b-F3MA	46	Insoluble at conditions tried	
THPMA-b-F3MA	51	4500	45
THPMA-b-F3MA	56	6500	65
THPMA-b-F3MA	62	2800	45

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Solvent Replacement: Lithography



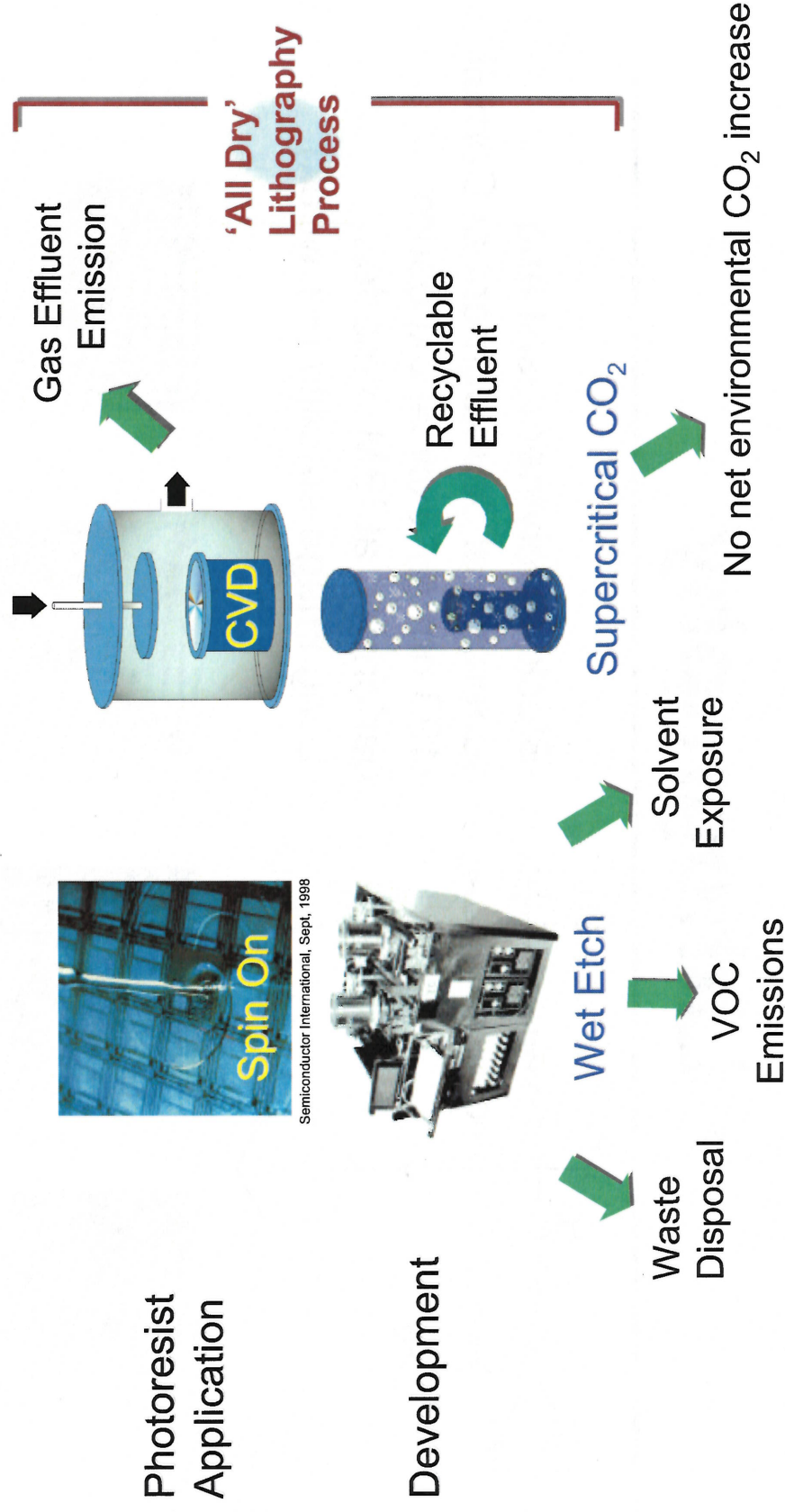
- Block copolymer resist and supercritical development at Cornell
- 193 nm ArF excimer exposure performed at IBM Almaden
- Long image stability (~1 week)



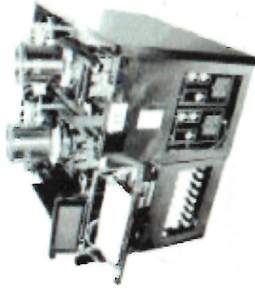
N. Sundararajan, S. Yang, J. Wang, K. Ogino, S. Valiyaveetil, C. K. Ober, S. K. Ober, S. K. Obendorf and R. D. Allen, "Resists Processed in Supercritical CO₂," *Chem. Mater.*, accepted.

Solvent Replacement

Thrust D: Lithography



Semiconductor International, Sept, 1998



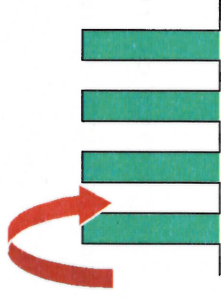
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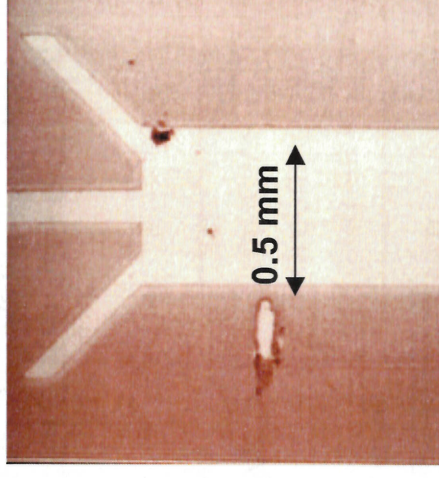
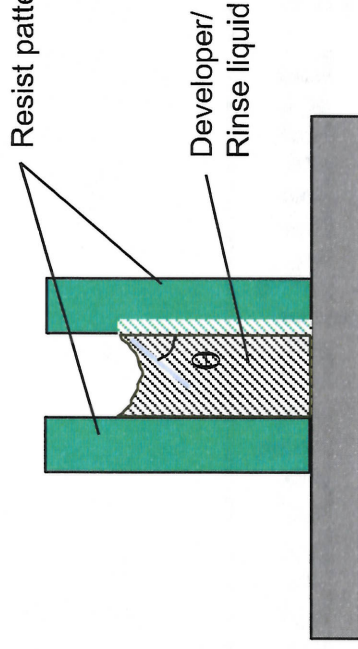
Solvent Replacement

Thrust D: Lithography

High Diffusivity: Enables even development of high aspect ratio features



Low surface tension: Prevents pattern collapse



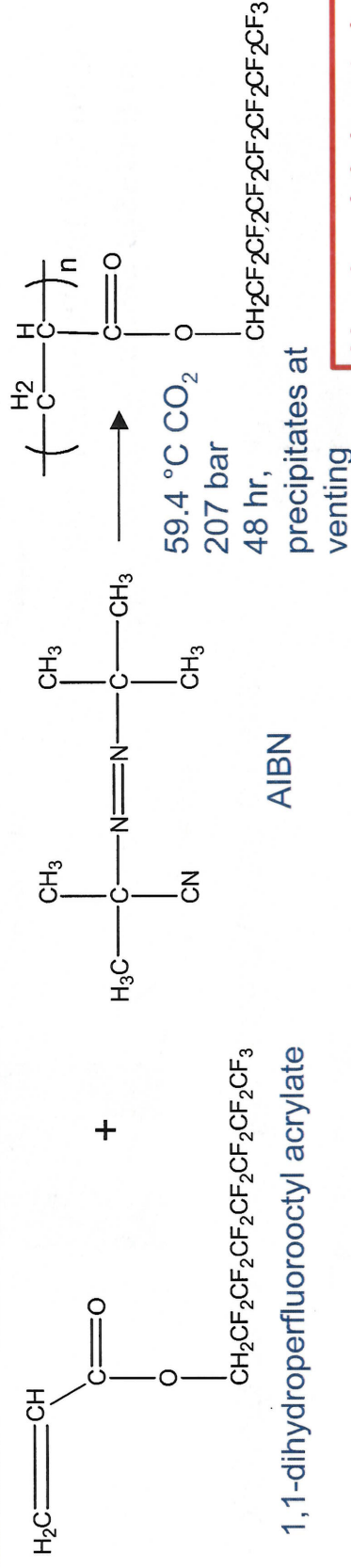
6000 $\mu\text{C}/\text{cm}^2$ CHFPO.HF7

Nonpolar: Enables dissolution of 157nm-transparent polymers

Organosilicon Fluorocarbon
 $\text{Si}:\text{C}:\text{O}:\text{H}$ $-\text{CF}_2-\text{CF}_2-$

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Solvent Replacement: Fluoropolymer Polymerization



Used as lubricants in computer disk drives, protective coatings.

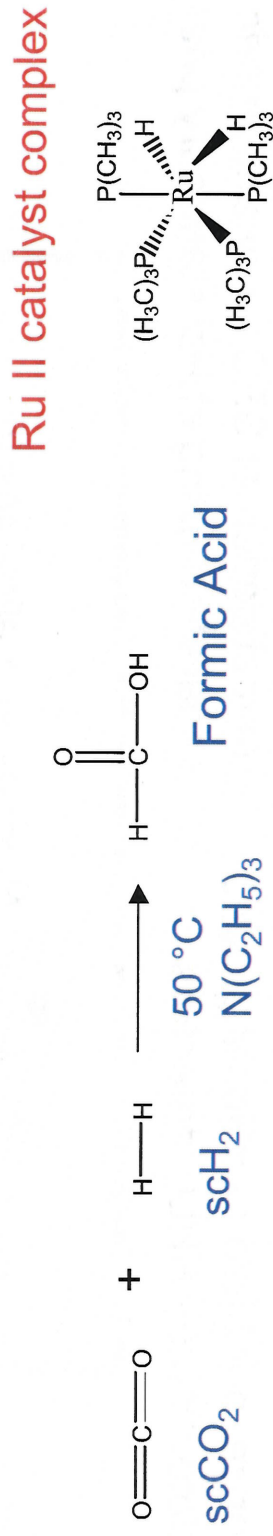
- Insolubility necessitates use of CFC solvents
- Solute-solvent interaction with F and CO₂ allows 25% solubility of high MW fluoropolymers (>250,000 g/mol)
- Wide range of solvent strengths in SCF by ΔP
- AIBN composition 2.5 times lower than in benzene (benzene has higher ε)
- Efficiency factor in CO₂ f=0.83, in benzene f=0.53: low viscosity aids diffusion and avoids recombination
- FOA copolymerized with ethylene, styrene, MMA, butyl acrylate

DeSimone et al: Science 1992, 257, 945

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Other Chemical Reactions:

CO₂ as a Reactant



- Successful hydrogenation of CO₂
- Homogenous catalysis with Ru II complex
- Addition of base to favor product formation
- Product obtained by pressure reduction
- Turnover frequency 1400 h⁻¹; in conventional water 290 h⁻¹

Jessop, Ikarlya, Noyori: Nature 1994, 368, 231

Supercritical Fluid Chromatography (SFC)

HPLC: 2 pumps provide mixed mobile phase, packed column in oven, pressure and flow-rates controlled.

SFC: Higher flow rates
Liquid-like solubility

GC: syringe pump & restrictor, flame-ionization detector.

SFC: Lower Temperatures

- Successful for analytes that won't vaporize, nor have functional groups for detection by HPLC detectors.
- High resolution & sensitivity.
- Investigation of SFC for enantiomeric separation using chiral stationary phase.



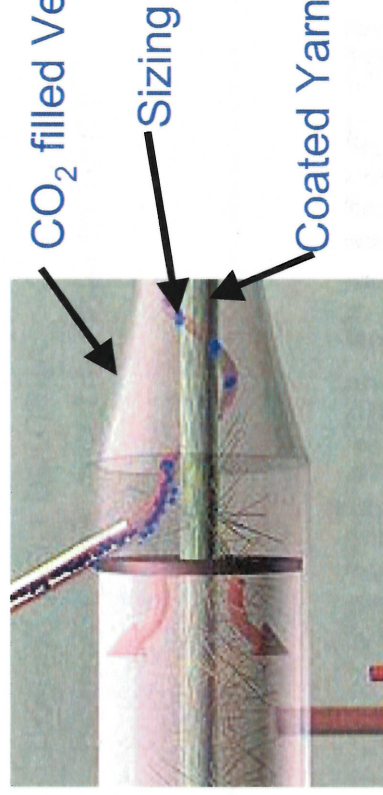
Nicotine and alkaloids in tobacco separated by SFC for analysis.

Polymer Additives

Textile Dyeing & Highly Reflective

Material:

- SCF CO₂ infusion of dye to synthetic fibers
- SCF CO₂ infusion of Si containing additive to PEEK
- Rapid CO₂ depressurization leaves additives behind



Textile Sizing:

- Coating a smooth PVA film on fibers to add strength before weaving.
- Adjustment of conditions allows control of penetration.
- Fibers do not stick together after drawing through SCF.



<http://scholar.lib.vt.edu/theses/available/etd-93097-173344/>

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Supercritical Fluid Drying

Silica aerogel :
permeability comparable to glass
matrix, high porosity.

Useful as heat or acoustic
insulation material

- Drying without vaporization
- No volume expansion from phase change
- No destruction of minute holes in silica gel
- Reactions in CO₂-swollen matrix to create composite materials
- Controlled depressurization renders dense composites
- Rapid pressure quenches yield expanded (microcellular foam) materials.



Thomas McCarthy <http://www.pse.umass.edu/faculty/mccarthy.html>

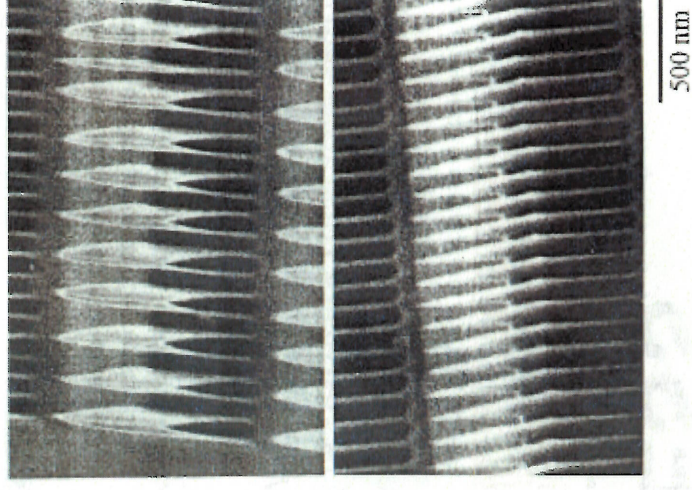
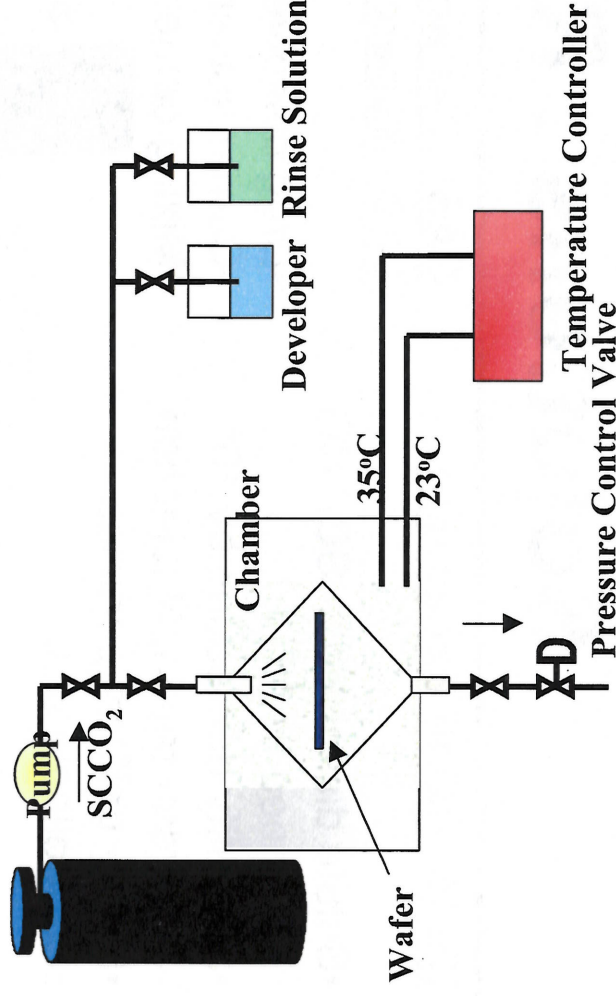
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Supercritical Fluid Drying

- Use CO₂ to replace water or polar solvents.
- Low surface tension avoids capillary forces/ pattern collapse

- N₂ / CO₂ combination used
- Very fine features created



1999 NTT LSI Laboratories, Japan

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Rapid Expansion of SCF

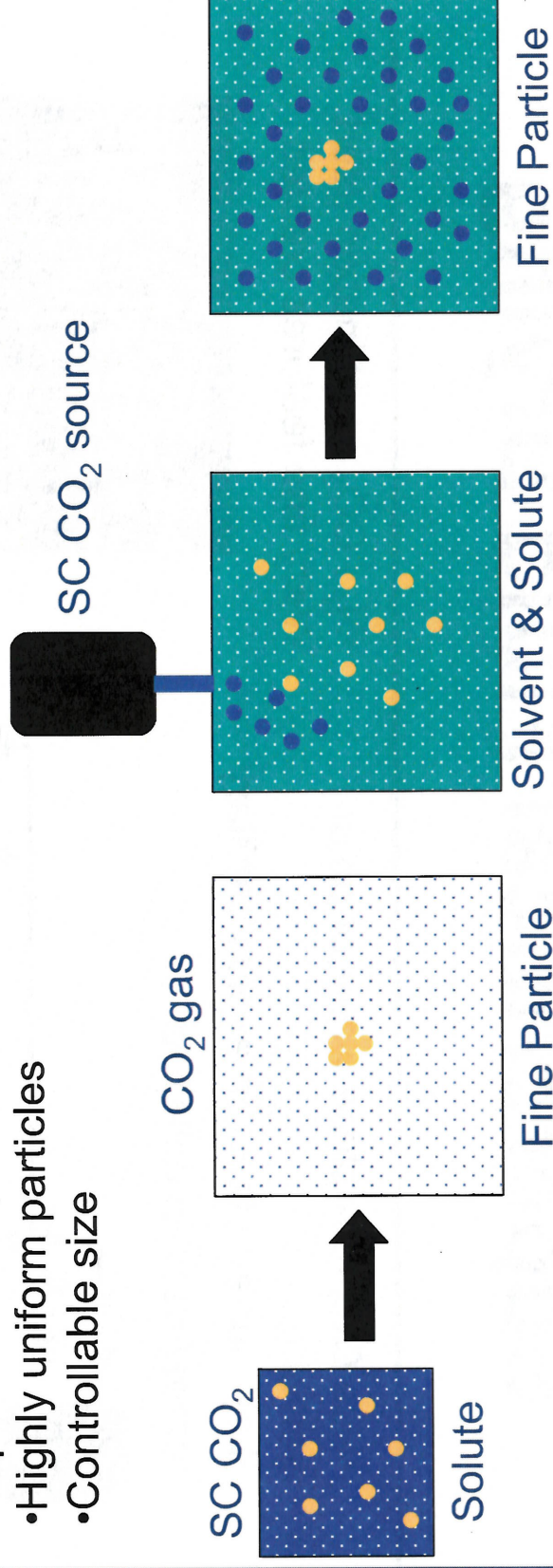
Solutions : RESS

RESS: Rapid Expansion:

- Solute dissolved in SCF CO_2
- Expanded to ATM
- Solubility decreases by 10^6
- Supersaturation, Nucleation
- Highly uniform particles
- Controllable size

GAS: Gas anti-solvent Approach SAS: Supercritical non-solvent

- Drug dissolves in carrier solvent, not CO_2
- Carrier solvent is partially miscible with CO_2
- Mixing carrier with SCF causes precipitation



RESS/ GAS Applications

Microencapsulation of Flavor and

Fragrance: (volatile, thermally labile, sensitive to oxidation, expensive)

- Release of flavors during microwaving
- Protection of aspartame during cooking
- Oxidation protection for oils and essences
- Protection during freeze/thaw cycles
- Mask potassium chloride taste
- Reduce flavor mixing: choline and vitamins
- Final product not contaminated with residual solvent
- Process does not degrade active agent as spray drying may



Pharmaceutical Application:

- Aerosol drugs require uniform particles and small size
- Must produce sterile powder
- CO₂ replaces aseptic conditions + use of EtO sterilizer

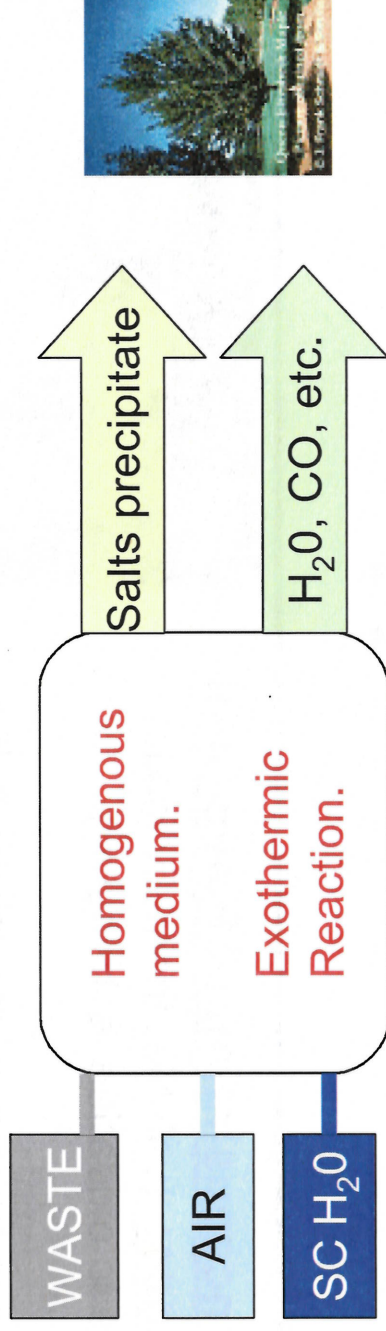
Supercritical Water Oxidation

SCWO: The oxidative destruction of organic wastes in supercritical water.

Above 550 °C toxic organic compounds are miscible, as are oxygen and peroxides in water. Inorganic salts are mostly insoluble.

Destruction of chemical warfare agents, toxic pharmaceuticals

Challenges include: separation of inorganic salts to prevent scaling, & corrosion arising from halogenated hydrocarbons.



EcoWaste Technologies

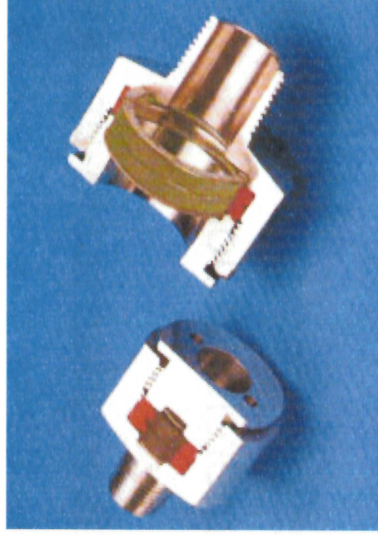
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Molecular-Level SCF Study

Requirements for Modeling Solubility:

- Properties of all solvents and solutes
- Equation of state: ideal gas, virial, VDW, cubic, Peng-Robinson, etc.
- Temperature dependence, attraction terms, component interaction parameters
- Short and long range (solvation and compressibility driven) effects for solutions



Determine solubility & dissolution behavior in CVD films; interferometry.

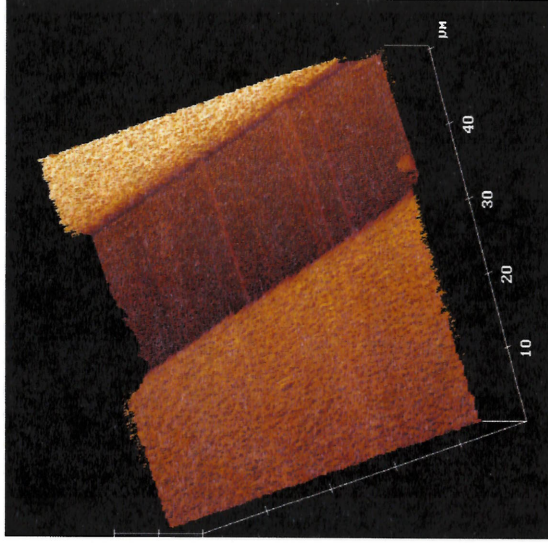
Modeling via regression:

- Based on quantitative structure-property relationships.
- Numerical descriptors may include electrostatic, geometric, and topological parameters, as well as F or other atomic content.

Challenges in SCF Technology

- Feasible designs for scale-up are necessary for commercialization
- Modeling for scale-up not always available/ accurate
- Absence of fundamental, molecular-based model of solutes in SCF
- Continuing instrumental & equipment improvements
- Continuing research & development for applications & new material design

Thrust D: Dry Lithography



AFM/SEM of CHFPO.HF7
Ebeam 6000 $\mu\text{C}/\text{cm}^2$

- Continuing progress in CO_2 developing of CVD deposited poly(fluoroethers)
- Environmentally benign alternative to aqueous base development
- Useful for patternable low k material
- Aid in resist design for 157 nm laser source or e-beam
- Study to identify structure/property relationships in SCF CO_2
- Study of dissolution behavior in films

SRC / NSF



Karen Gleason,
Hilton Pryce Lewis

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Conclusions

Supercritical Fluids:

- Have unique properties, including high diffusivity, low surface tension, low dielectric constant, and continuously variable density.
- Are non-flammable, non-toxic, inexpensive and do not require special disposal.

Provide alternatives for solvents in cleaning, extraction, and synthesis applications.

- Provide capability for manufacturing specially structured materials, which cannot be produced conventionally.
- Provide new capability for extraction, chromatography, and toxic waste elimination.